Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition
1 BRS	8	(438/612.ccls. and polymer) and (conductive near polymer)	USPAT	2004/06/0 8 15:53		
2 BRS	48	438/612.ccls. and polymer	USPAT	2001/03/0 9 17:44		
3 BRS	2053	semiconductor near carrier	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/03/1 2 12:42		
4 BRS	0	(semiconductor near carrier) and membrane and (conductive near polymer)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/03/0 9 17:54		
5 BRS	22	(semiconductor near carrier) and membrane	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/03/0 9 17:48		

Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition
BRS	5	(((semiconductor near carrier) and membrane) and polymer) and conduct$	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/03/0 9 17:48		Truncation Overflo w. Return string from Server is: 5'0'C ON
BRS	6	(semiconductor near carrier) and (conductive near polymer)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/03/0 9 17:56		Truncat ion Overflo w. Return string from Server is:
BRS	0	(soldr near bump$) and (conduct$ near polymer)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/03/0 9 17:57		Truncat ion Overflo w. Return string from Server is: 5'9'11' SO

Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition
9 BRS	2057	semiconductor near carrier	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/03/1 2 15:13		
10 BRS	6	(semiconductor near carrier) and membrane and polymer	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/03/1 2 12:43		
11 BRS	1065	438/118,119,613,614,65 0.ccls.	USPAT	2001/03/1 2 16:25		
12 BRS	32	438/118,119,613,614,65 0.ccls. and (conductive near polymer)	USPAT	2001/03/1 2 15:16		
13 BRS	211	(semiconductor near carrier) and gold	USPAT	2001/03/1 2 15:16		
14 BRS	3	((semiconductor near carrier) and gold) and (conduct$ adj polymer)	USPAT	2001/03/1 2 15:11		Truncation Overflow. Return string from Server is: 5`0`0`C ON

Typ e	Hits	Search Text	DBs	Time Stamp	Comment s	Error Definit ion
15 BRS	4539	semiconductor near (carrier or carrier or assembly)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/03/1 2 15:14		
16 BRS	601	(semiconductor near (carrier or carrier or assembly)) and gold	USPAT	2001/03/1 2 15:16		
17 BRS	28	((semiconductor near (carrier or carrier or assembly)) and gold) and (conductive near polymer)	USPAT	2001/03/1 2 16:01		
18 BRS	441	epoxy near5 (bump or ball)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/03/1 2 16:02		
19 BRS	20	(epoxy near5 (bump or ball)) and (conductive near polymer)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/03/1 2 16:03		
20 BRS	1220	257/737,738,778.ccls.	USPAT	2001/03/1 2 16:25		
20 BRS	1220	257/737,738,778.ccls.	USPAT	2001/03/1 2 16:25		
21 BRS	31	257/737,738,778.ccls. and (epoxy near5 (bump or ball))	USPAT	2001/03/1 2 18:28		
22 BRS	570	228/180.22.ccls.	USPAT	2001/03/1 2 16:49		

Typ e	Hits	Search Text	DBs	Time Stamp	Comment s	Error Definit ion
23	BRS	13	228/180.22.ccls. and (epoxy near5 (bump or ball))	USPAT	2001/03/1 2 16:50		
24	BRS	7	(semiconductor near (carrier or carrier or assembly)) and (gold near ball)	USPAT	2001/03/1 2 18:29		
25	BRS	6	((semiconductor near carrier) and membrane) and polymer	USPAT; EPO; JPO; DERWENT; IBM_TDB _	2001/03/1 3 11:18		
26	BRS	1825	bump same (carrier or interposer) same chip	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB _	2001/06/1 3 17:57		
27	BRS	99	(bump same (carrier or interposer) same chip) same (alternative$ or interchange$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/06/1 3 18:47		
28	IS& R	1	("4875617").PN.	USPAT	2001/06/1 3 18:47		
29	IS& R	1	("6376352").PN.	USPAT	2004/06/0 8 11:14		

Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition
30 BRS	4723	compliant and epoxy	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/0 8 11:14		
31 BRS	412	compliant with epoxy	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/0 8 11:15		
32 BRS	207	(compliant with epoxy) and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/0 8 11:15		
33 BRS	57	((compliant with epoxy) and semiconductor) and BGA	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/0 8 11:26		
34 BRS	95	bump with epoxy with coat$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/0 8 11:26		

Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition
35						
BRS	30	(bump with epoxy with coat$3) and gold	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/08 11:27		